

800mA Fixed Output Voltage Linear Regulator

1 Features

- Rated Output Current: 0.8A
- Current Limit: 1.15A
- Output Noise: 0.003% (10Hz to 10kHz)
- PSRR: 70 dB (300mA, 120Hz)
- Output Voltage Accuracy: $\pm 1\%$
- On-chip Thermal Shutdown
- Maximum Quiescent Current: 5mA (Max)
- No External Components
- Compatible with Low ESR Ceramic Capacitor
- Operation Junction Temperature: -40 to 125°C
- RoHS Compliant and Halogen-Free

2 Applications

- USB devices
- TV and Monitors
- Add-on cards
- Mother Boards

3 Description

The GD30LD1117 is low dropout three-terminal regulators optimized for low voltage where transient response and minimum input voltage are critical. The device provides current-limit and thermal-shutdown features. Its circuit includes a trimmed bandgap reference to assure output voltage accuracy of within $\pm 1\%$. On-chip thermal shutdown provides protection against a combination of high current and ambient temperature that would create excessive junction temperature.

The GD30LD1117BSTR-I is available in fixed output voltage versions of 3.3V, 5.0V, and an adjustable output voltage version which can set the output voltage with two external resistors. The GD30LD1117BWTR is available in fixed output voltage version of 3.3V and 5.0V.

The GD30LD1117BSTR is available in the industry-standard SOT223 package, and GD30LD1117BWTR is SOT-89.

Device Information¹

PART NUMBER	PACKAGE	BODY SIZE (NOM)
GD30LD1117	SOT223	6.55 mm x 3.55 mm
	SOT89	4.50 mm x 2.45 mm

1. For all available packages, see the [Package Information](#) and [Ordering Information](#) at the end of data sheet.

Simplified Application Schematic

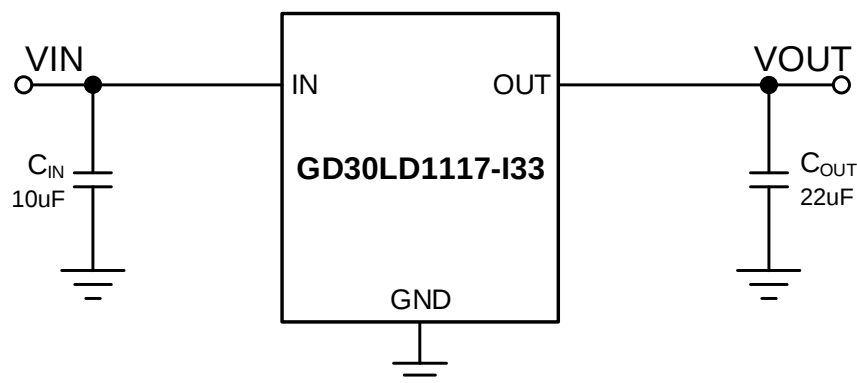
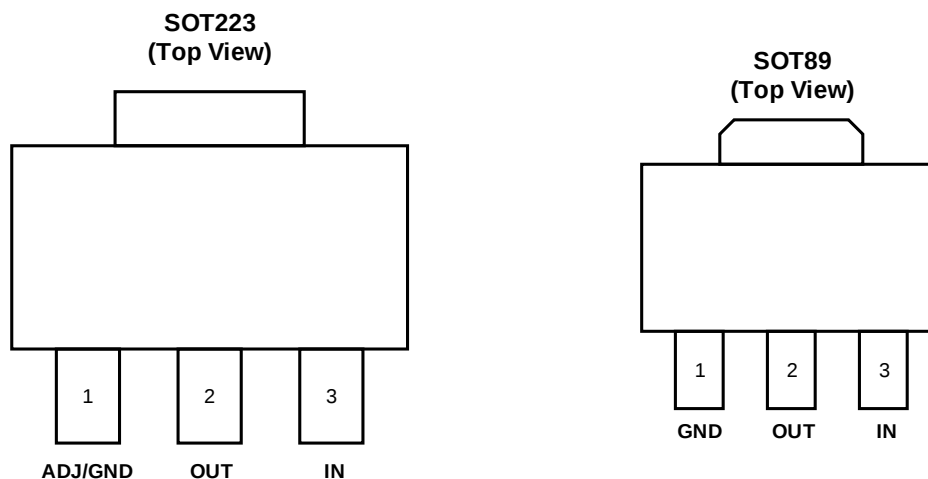


Table of Contents

1	Features	1
2	Applications	1
3	Description.....	1
	Table of Contents	2
4	Device Overview.....	3
4.1	Pinout and Pin Assignment	3
4.2	Pin Description	3
5	Parameter Information	4
5.1	Absolute Maximum Ratings.....	4
5.2	Recommended Operation Conditions	4
5.3	Electrical Sensitivity	4
5.4	Electrical Characteristics	4
5.5	Typical Characteristics	7
6	Functional Description	8
6.1	Block Diagram.....	8
7	Application Information	9
7.1	Typical Application Circuit	9
8	Layout Guidelines and Example.....	10
9	Package Information	11
9.1	Outline Dimensions	11
10	Ordering Information	14
11	Revision History	15

4 Device Overview

4.1 Pinout and Pin Assignment



4.2 Pin Description

NAME	PIN NUMBER		PIN TYPE ¹	FUNCTION
	SOT223	SOT89		
ADJ/GND	1	1	G	Adjust pin for adjustable output option. Ground pin for fixed output option.
OUT	2	2	P	Output pin.
IN	3	3	P	Power supply input pin.

1. I = Input, P = Power, G = Ground.

5 Parameter Information

5.1 Absolute Maximum Ratings

Exceeding the operating temperature range(unless otherwise noted)¹

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{IN}	Input Voltage		20	V
T_J	Operating Junction Temperature		150	°C
T_{LEAD}	Lead Temperature (Soldering, 10sec)		260	°C
T_{STG}	Storage Temperature Range	-65	150	°C

1. The maximum ratings are the limits to which the device can be subjected without permanently damaging the device. Note that the device is not guaranteed to operate properly at the maximum ratings. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

5.2 Recommended Operation Conditions

SYMBOL ¹	PARAMETER	MIN	TYP	MAX	UNIT
V_{IN}	Input supply voltage range			18	V
T_J	Operating junction temperature	-40		125	°C

1. The device is not guaranteed to function outside of its operating conditions.

5.3 Electrical Sensitivity

SYMBOL	CONDITIONS	VALUE	UNIT
$V_{ESD(HBM)}$	Human-body model (HBM), ANSI/ESDA/JEDEC JS-001-2017 ¹	±3000	V
$V_{ESD(CDM)}$	Charge-device model (CDM), ANSI/ESDA/JEDEC JS-002-2022 ²	±500	V

1. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
2. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

5.4 Electrical Characteristics

$V_{IN} < 10V$, $I_O = 10mA$, $T_J = 25^\circ C$, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$V_{OUT} = 1.8V$						
V_{OUT}	Output voltage	25°C	1.782	1.8	1.818	V
		-20°C to 125°C	1.764	1.8	1.836	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, -20°C to 125°C			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	5	mA
I_{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB

Electrical Characteristics (Continued)

$V_{IN} < 10V$, $I_O = 10mA$, $T_J = 25^{\circ}C$, unless otherwise noted.

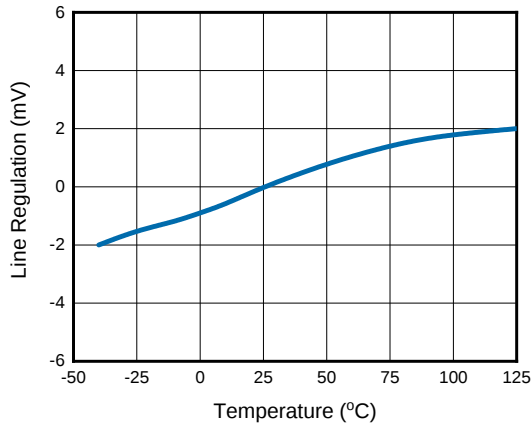
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Hysteresis			16		$^{\circ}C$
$V_{OUT} = 2.5V$						
V_{OUT}	Output voltage	$25^{\circ}C$	2.475	2.5	2.525	V
		$-20^{\circ}C$ to $125^{\circ}C$	2.455	2.5	2.545	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	5	mA
I_{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Hysteresis			16		$^{\circ}C$
$V_{OUT} = 3.3V$						
V_{OUT}	Output voltage	$25^{\circ}C$	3.267	3.3	3.333	V
		$-20^{\circ}C$ to $125^{\circ}C$	3.235	3.3	3.365	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	5	mA
I_{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$

Electrical Characteristics (Continued)

 $V_{IN} < 10V$, $I_O = 10mA$, $T_J = 25^{\circ}C$, unless otherwise noted.

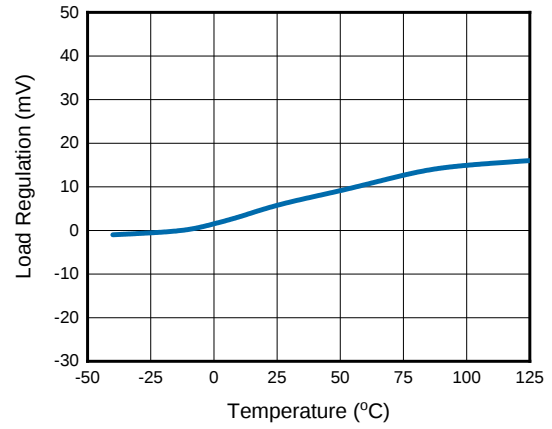
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$V_{OUT} = 5V$						
V_{OUT}	Output voltage	$25^{\circ}C$	4.950	5.0	5.050	V
		$-20^{\circ}C$ to $125^{\circ}C$	4.900	5.0	5.10	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	6	mA
I_{LIM}	Current limit		0.9	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$
$V_{OUT} ADJ$						
V_{REF}	Reference voltage	$1.5V \leq V_{IN} - V_O \leq 10V$, $25^{\circ}C$	1.238	1.250	1.262	V
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$	1.225	1.250	1.270	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$, $25^{\circ}C$		0.001	0.1	%
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			0.2	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		0.4	1	mV
I_{ADJ}	Adjust Pin Current	$1.5V \leq V_{IN} - V_O \leq 10V$		60	120	μA
ΔI_{ADJ}	Adjust Pin Current Change			0.2	0.5	μA
I_{MIN}	Minimum Load Current	$1.5V \leq V_{IN} - V_O \leq 10V$		1.7	5	mA
I_{LIM}	Current limit		0.9	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$

5.5 Typical Characteristics



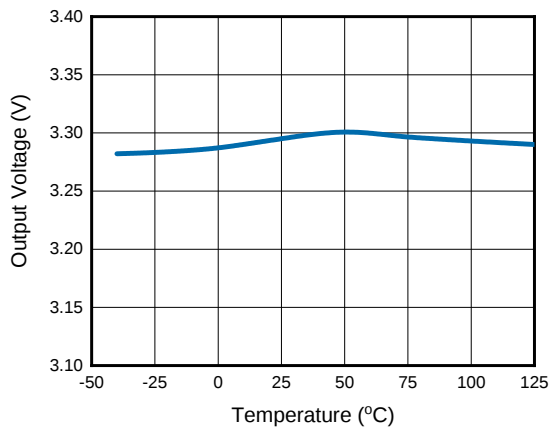
$V_{IN} = 4.8V$ to $13.3V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$

Figure 1. Line Regulation vs. Temperature



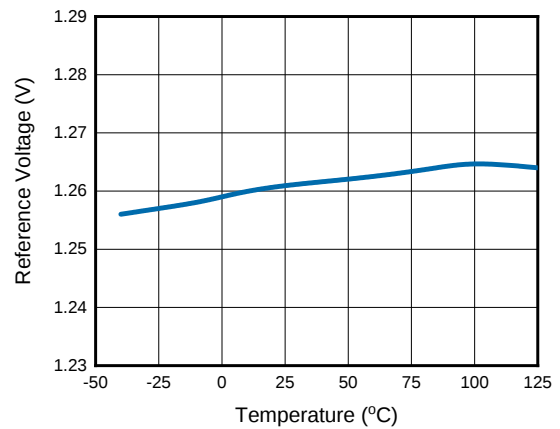
$V_{IN} = 5V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$ to $0.8A$

Figure 2. Load Regulation vs. Temperature



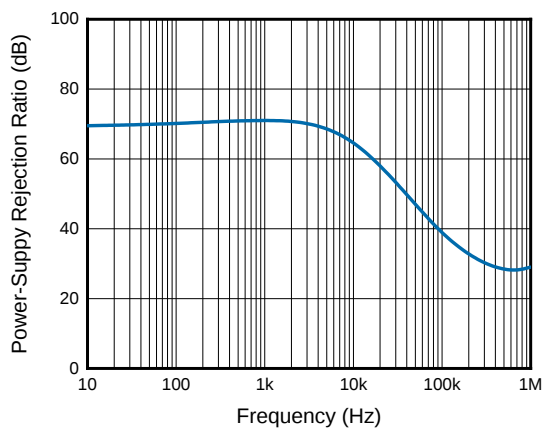
$V_{IN} = 5V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$

Figure 3. Output Voltage vs. Temperature



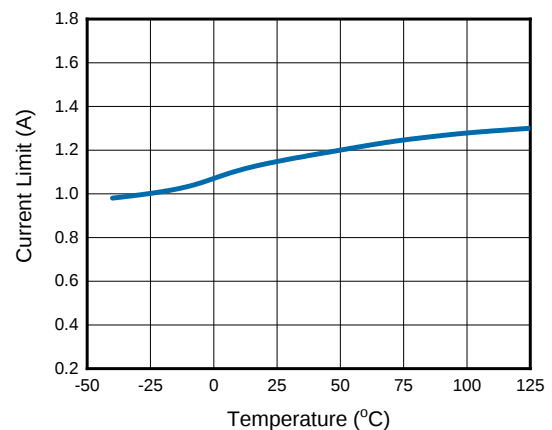
$V_{IN} = 5V$, $V_{OUT} = \text{ADJ}$, $I_{OUT} = 10mA$

Figure 4. Reference Voltage vs. Temperature



$V_{IN} = V_{OUT} + 2V_{DC}$, $V_{OUT} = \text{ADJ}$, $I_{OUT} = 100mA$

Figure 5. PSRR vs. Frequency



$V_{IN} = V_{OUT} + 1.5V$, $V_{OUT} = \text{ADJ}$

Figure 6. Current Limit vs. Temperature

6 Functional Description

6.1 Block Diagram

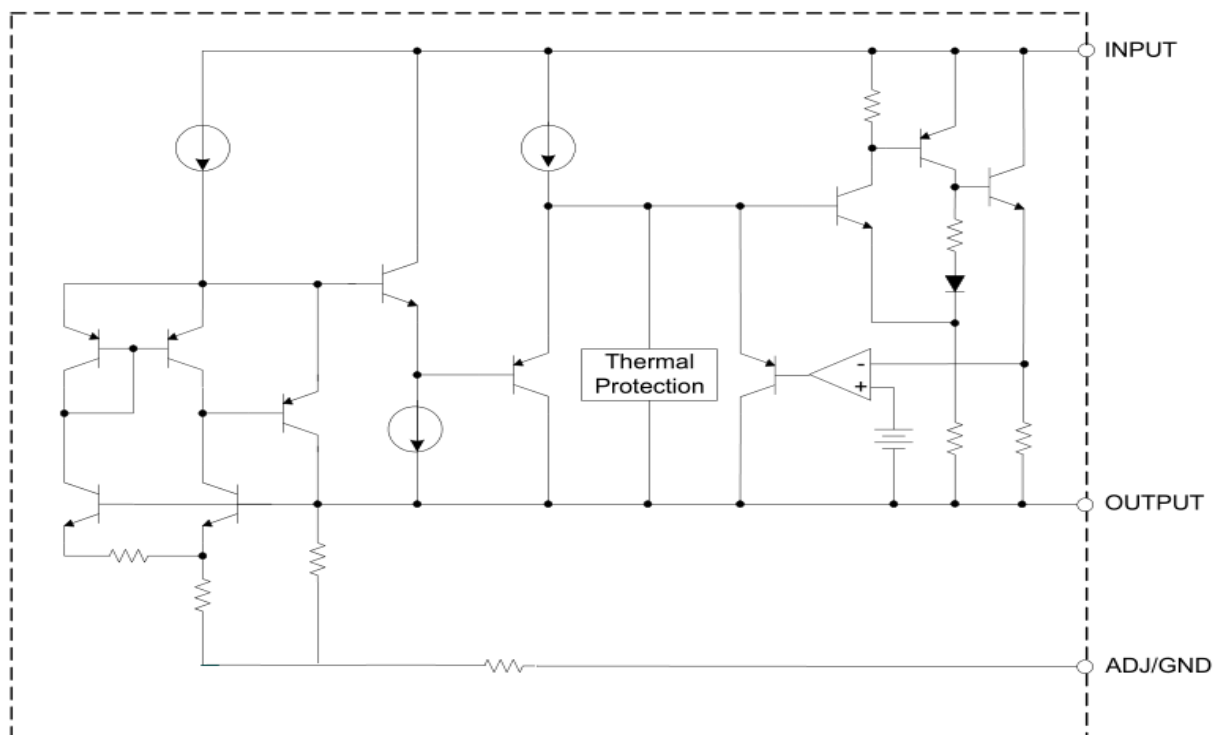


Figure 7. GD30LD1117 Functional Block Diagram

7 Application Information

7.1 Typical Application Circuit

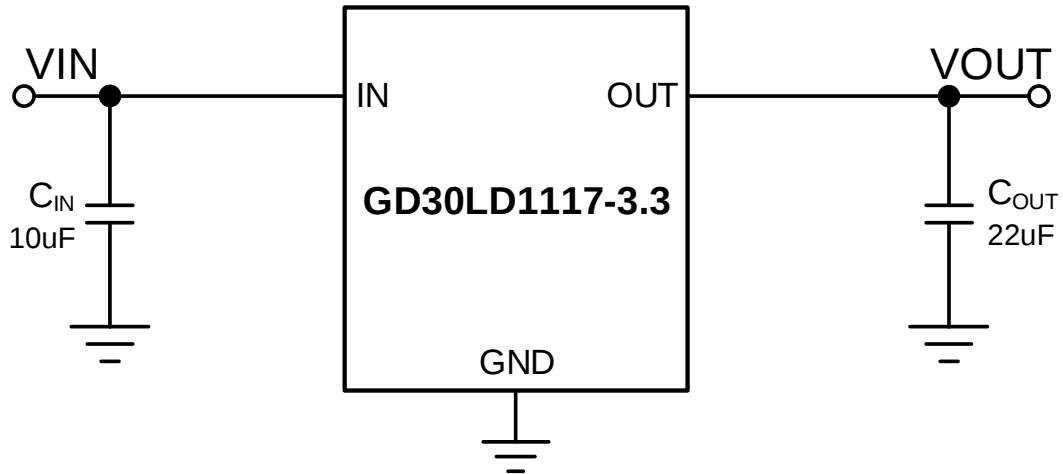
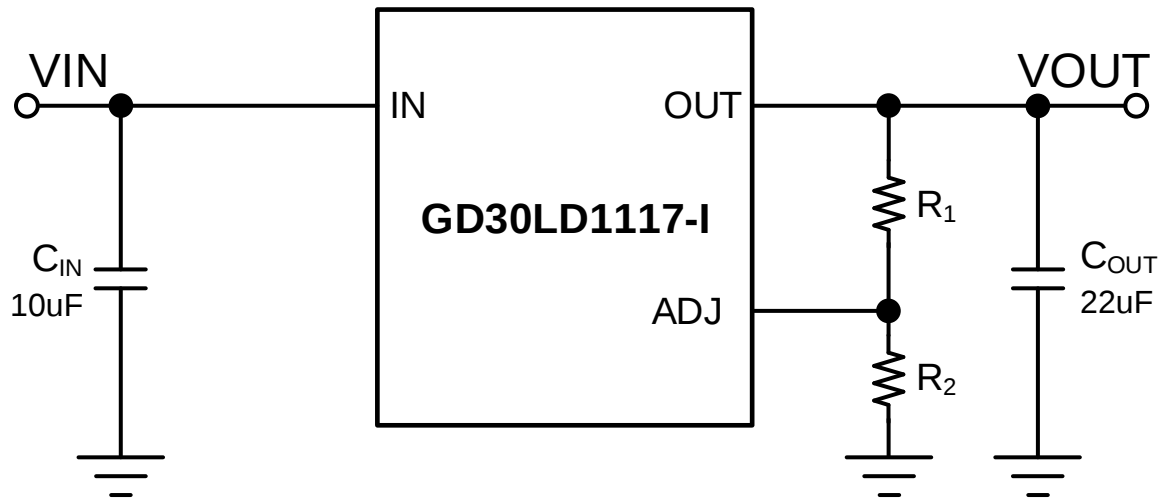


Figure 8. Reference Design Schematic of Fixed-Output



$$V_{OUT} = V_{REF} \times (1 + R_2/R_1) + I_{ADJ} \times R_2$$

Figure 9. Reference Design Schematic of Adjust-Output

8 Layout Guidelines and Example

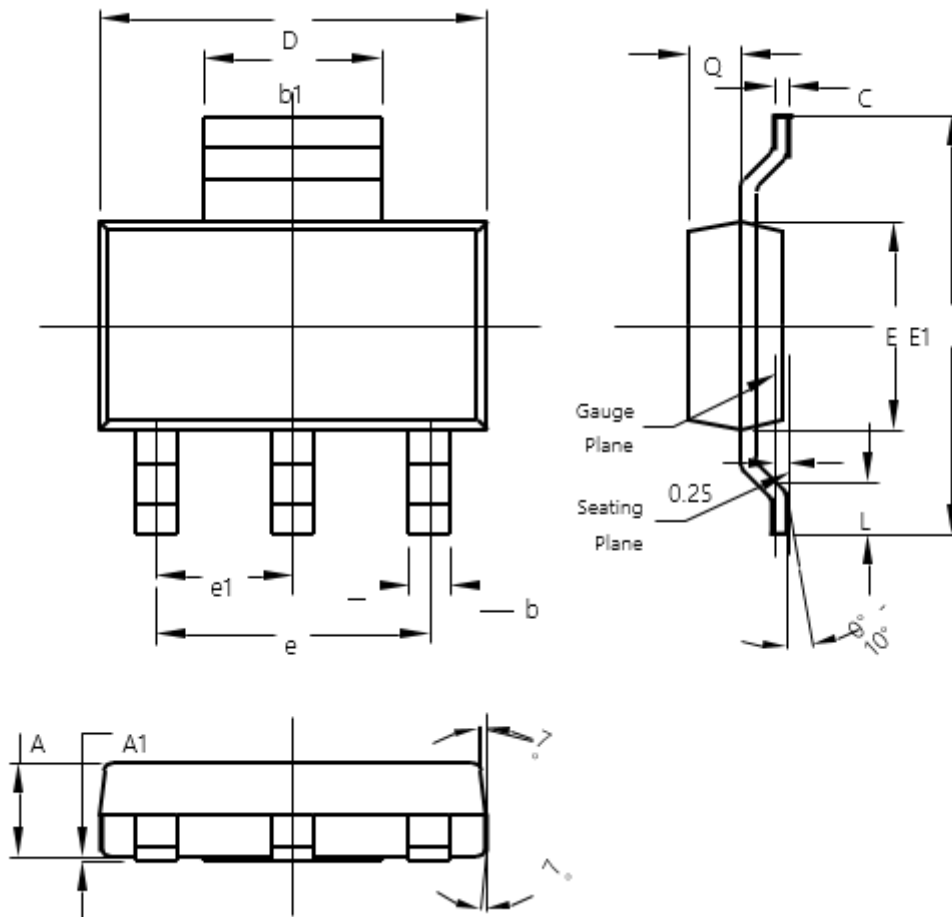
By placing input and output capacitors on the same side of the PCB as the LDO, and placing them as close as is practical to the package can achieve the best performance. The ground connections for input and output capacitors must be back to the GD30LD1117 ground pin using as wide and as short of a copper trace as is practical.

Connections using long trace lengths, narrow trace widths, and/or connections through via must be avoided. These add parasitic inductances and resistance that results in worse performance especially during transient conditions.

9 Package Information

9.1 Outline Dimensions

SOT223



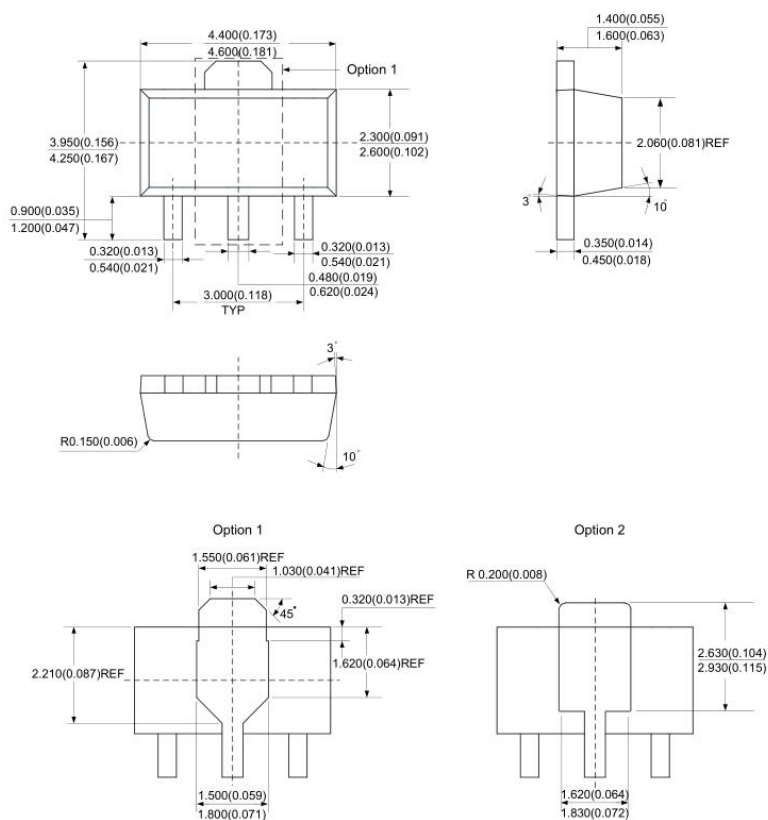
NOTES:

1. All dimensions are in millimeters.
2. Package dimensions does not include mold flash, protrusions, or gate burrs.
3. Refer to the [Table 1 SOT223 dimensions\(mm\)](#).

Table 1. SOT223 dimensions(mm)

SYMBOL	MIN	NOM	MAX
A	1.55	1.60	1.65
A1	0.01	0.05	0.15
b	0.60	0.70	0.80
b1	2.90	3.10	3.00
c	0.20	0.25	0.30
D	6.45	6.50	6.55
E	3.45	3.50	3.55
E1	6.90	7.00	7.10
e		4.60	
e1		2.30	
L	0.85	0.95	1.05
Q	0.84	0.89	0.94

SOT-89



NOTES(Continued):

1. All dimensions are in millimeters.
2. Package dimensions does not include mold flash, protrusions, or gate burrs.

10 Ordering Information

Ordering Code	Package Type	ECO Plan	Packing Type	MOQ	OP Temp(°C)
GD30LD1117BSTR-I	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I18	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I25	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I33	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I50	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BWTR-I33	SOT89	Green	Tape & Reel	1000	-40°C to +125°C
GD30LD1117BWTR-I50	SOT89	Green	Tape & Reel	1000	-40°C to +125°C

11 Revision History

REVISION NUMBER	DESCRIPTION	DATE
1.0	Initial release and device details	2024

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